1. (1) external 5.25" drive bay
2. 300 W power supply
3. Rear I/O includes: (4) USB 2.0 ports, RJ-45 Ethernet Port, DVI-D and VGA video ports, audio in/out jacks (5.1 channel audio out)
4. Front I/O includes: (2) USB 2.0 ports, dedicated headphone port, microphone jack
5. (1) internal 3.5" hard drive bay
6. (3) PCIe x1 slots, (1) PCIe x16 slot, (1) MiniPCIe slot
7. USB Scroll Mouse
8. HP USB Standard Value Keyboard
9. HP Monitor (sold separately)
QuickSpecs

HP Pro 3500 Microtower Desktop PC

Overview

At A Glance

- Choice of Intel® Celeron™, Intel Pentium™ and Intel Core™ i3, Intel Core i5, and Intel Core i7 next generation processors
- Intel H61 Express Chipset
- Up to 8 GB DDR3 1600 MHz SDRAM system memory available standard (depending on model)
- Up to 2 TB 6.0 Gb/s SATA hard drive
- SuperMulti DVD+/−RW Drive or DVD ROM Drive
- Integrated Realtek RTL8171E Gigabit Ethernet Controller
- (6) USB 2.0 ports, including (2) Front, (4) rear
- DVI-D and VGA video ports with that support independent dual display
- HP Wireless NIC 802.11b/g/n Mini Card (1x1) (optional)
- 5.1 audio channels
- Protected by HP Services. Terms and conditions vary by country. Certain restrictions and exclusions apply.
OPERATING SYSTEMS

Preinstalled
- Windows 8 Pro (64-bit)*
- Windows 8 (64-bit)*
- Windows® 7 Ultimate (32-bit or 64-bit)**
- Windows® 7 Professional (32-bit or 64-bit)**
- Windows® 7 Home Premium (32-bit or 64-bit)**
- Windows® 7 Home Basic (64-bit)**
- Windows® Starter (32-bit)***
- FreeDOS 2.0
- FreeLnx

*Not all features are available in all editions of Windows 8. Systems may require upgraded and/or separately purchased hardware, drivers and/or software http://www.microsoft.com/windows/windows-8/ for details. to take full advantage of Windows 8 functionality. See http://www.microsoft.com.

**Not all features are available in all editions of Windows 7. This system may require upgraded and/or separately purchased hardware to take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.

*** Restrictions exist for this operating system. It is not available in some countries and is not compatible with some CPUs. Please check for availability.

PROCESSOR

Intel® 3rd Generation Core™ i7 Processors
- Intel® Core™ i7-3770 with Intel HD Graphics 4000 (3.40 GHz, 8 MB cache, 4 cores)
  8 threads. Intel Stable Image Platform Program (SIPP)

Intel® 3rd Generation Core™ i5 Processors
- Intel® Core™ i5-3470 with Intel HD Graphics 2500 (3.20 GHz, 6 MB cache, 4 cores)
  4 threads. Intel Stable Image Platform Program (SIPP)

Intel® 2nd Generation Core™ i7 Processors
- Intel® Core™ i7-2600 with Intel HD Graphics 2000 (3.40 GHz, 8 MB cache, 4 cores)
  8 threads. Up to 3.80 GHz with Intel Turbo Boost Technology

Intel® 2nd Generation Core™ i5 Processors
- Intel® Core™ i5-2500 with Intel HD Graphics 2000 (3.30 GHz, 6 MB cache, 4 cores)
  4 threads. Up to 3.70 GHz with Intel Turbo Boost Technology
- Intel® Core™ i5-2400 with Intel HD Graphics 2000 (3.10 GHz, 6 MB cache, 4 cores)
  4 threads. Up to 3.40 GHz with Intel Turbo Boost Technology
- Intel® Core™ i5-2320 with Intel HD Graphics 2000 (3.00 GHz, 6 MB cache, 4 cores)
  4 threads. Up to 3.30 GHz with Intel Turbo Boost Technology
- Intel® Core™ i5-2310 with Intel HD Graphics 2000 (2.90 GHz, 6 MB cache, 4 cores)
  4 threads. Up to 3.20 GHz with Intel Turbo Boost Technology
- Intel® Core™ i5-2300 with Intel HD Graphics 2000 (2.80 GHz, 6 MB cache, 4 cores)
  4 threads. Up to 3.10 GHz with Intel Turbo Boost Technology
Standard Features and Configurable Modules

**Intel® 2nd Generation Core™ i3 Processors**

Intel® Core™ i3-2130 with Intel HD Graphics 2000 (3.40 GHz, 3 MB cache, 2 cores)
4 threads

Intel® Core™ i3-2125 with Intel HD Graphics 3000 (3.30 GHz, 3 MB cache, 2 cores)
4 threads

Intel® Core™ i3-2120 with Intel HD Graphics 2000 (3.30 GHz, 3 MB cache, 2 cores)
4 threads

Intel® Core™ i3-2105 with Intel HD Graphics 3000 (3.10 GHz, 3 MB cache, 2 cores)
4 threads

Intel® Core™ i3-2100 with Intel HD Graphics 2000 (3.10 GHz, 3 MB cache, 2 cores)
4 threads

**Intel® Pentium® Processors**

Intel® Pentium® G870 with Intel HD Graphics (3.10 GHz, 3 MB cache, 2 cores)
2 threads

Intel® Pentium® G860 with Intel HD Graphics (3.00 GHz, 3 MB cache, 2 cores)
2 threads

Intel® Pentium® G850 with Intel HD Graphics (2.90 GHz, 3 MB cache, 2 cores)
2 threads

Intel® Pentium® G840 with Intel HD Graphics (2.80 GHz, 3 MB cache, 2 cores)
2 threads

Intel® Pentium® G640 with Intel HD Graphics (2.80 GHz, 3 MB cache, 2 cores)
2 threads

Intel® Pentium® G630 with Intel HD Graphics (2.70 GHz, 3 MB cache, 2 cores)
2 threads

Intel® Pentium® G620 with Intel HD Graphics (2.60 GHz, 3 MB cache, 2 cores)
2 threads

**Intel® Celeron® Processors**

Intel® Celeron® G540 with Intel HD Graphics (2.50 GHz, 2 MB cache, 2 cores)
2 threads

Intel® Celeron® G530 with Intel HD Graphics (2.40 GHz, 2 MB cache, 2 cores)
2 threads

Intel® Celeron® G440 with Intel HD Graphics (1.60 GHz, 1 MB cache, 1 core)
1 thread

**CHIPSET**

Intel® H61 Express
Standard Features and Configurable Modules

GRAPHICS

Integrated (depends on processor)
Intel HD Graphics: Basic, 2000, 3000, 2500, 4000

Discrete
AMD Radeon HD 7350 (512 MB)
AMD Radeon HD 7450 (1 GB)
AMD Radeon 7570 (2 GB)
NVIDIA GeForce GT630 (2 GB)
NVIDIA GeForce GT620 (1 GB)
NVIDIA GeForce GT530 (2 GB)
NVIDIA GeForce GT520 (1 GB)

STORAGE

SATA Hard Drive
250 GB, 7200 rpm, SATA 6.0 Gb/s, SMART IV, 3.5"
500 GB, 7200 rpm, SATA 6.0 Gb/s, SMART IV, 3.5"
1 TB, 7200 rpm, SATA 6.0 Gb/s, SMART IV, 3.5"
1.5 TB, 7200 rpm, SATA 6.0 Gb/s, SMART IV, 3.5"
2 TB, 7200 rpm, SATA 6.0 Gb/s, SMART IV, 3.5"
1.5 TB, 5400 rpm, SATA 6.0 Gb/s, SMART IV, 3.5"
2 TB, 5400 rpm, SATA 6.0 Gb/s, SMART IV, 3.5"

Optical Disc Drive
SATA DVD-ROM
SATA SuperMulti DVD+/-RW

Media Card Reader
HP 6-in-1
**DRIVE SUPPORT**

<table>
<thead>
<tr>
<th></th>
<th>Maximum Quantity Supported</th>
<th>Position Supported</th>
<th>Controller</th>
</tr>
</thead>
<tbody>
<tr>
<td>Media Reader</td>
<td>1</td>
<td>2</td>
<td>Internal USB 2.0 port</td>
</tr>
<tr>
<td>SuperMulti DVD Drive</td>
<td>1</td>
<td>1</td>
<td>SATA</td>
</tr>
<tr>
<td>3.5&quot; SATA Hard Drive</td>
<td>1</td>
<td>3</td>
<td>SATA</td>
</tr>
</tbody>
</table>

**MEMORY**

**Type**
Non-ECC, DDR3 1600 MHz SDRAM UDIMM

**NOTE:** Memory will run at 1333 MHz due to processor/chipset limitations

**Maximum**
8 GB

**# of Slots**
2 DIMM

**NOTE:** For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system.
Standard Features and Configurable Modules

**NETWORKING/COMMUNICATIONS**

**Ethernet (RJ-45)**
Realtek RTL8171E Gigabit Ethernet Controller (standard)

**Wireless**
802.11b/g/n PCIe x1 (optional)
802.11b/g/n Mini Card (optional)

**AUDIO/MULTIMEDIA**

Realtek ALC656
Business Headset

**KEYBOARDS AND POINTING DEVICES**

**Keyboard**
HP USB Value Keyboard

**Mice**
HP USB Optical Mouse

**SECURITY**

HP Business PC Security Lock Kit (optional)
HP Keyed Cable Lock Kit (optional)

**SOFTWARE**

**Preinstalled** (varies by country, list below with Windows 8, certain items not included with other operating systems)

(Buy Office)

**Browser and Toolbars**
- Internet Explorer 10
- Norton Toolbar

**Security and Protection**
- HP Client Security

**Productivity**
- Buy Office
Standard Features and Configurable Modules

Optical Disc Drive Playback and TV Tuners

- CyberLink PowerDVD
- Avermedia TV app
- Hauppauge TV app

Windows® Live™

- Movie Maker
- Writer
- Photo Gallery

Windows 8 applications

- Mail
- Calendar
- People
- SkyDrive
- Photos
- Messaging

Photos and Videos

- CyberLink YouCam
- CyberLink Media Suite
- CyberLink Power2Go
- CyberLink Label Print

A/V Integration

- HP Connected Remote

Audio Post Processing

- Beats Audio™

Games

- HP Games by WildTangent

Communication

- Broadband connection utility
- HP MyRoom

Utilities and Support

- HP Online User Guide
- HP Recovery Manager
- HP Support Assistant
- HP MyDisplay
- HP ePrint (driver)
POWER

Power Supply
300 W, active PFC or 300 W regular
100 - 240 VAC Rated Voltage Range

WEIGHTS & DIMENSIONS

Weight
System Weight
15.28 lbs to 15.83 lbs (approximate)
6.932 kg to 7.18 kg (approximate)

Dimensions (W x D x H)
Chassis
6.50 x 15.31 x 14.49 in
16.5 x 38.9 x 36.8 cm

PORTS

I/O Ports - Standard
6 - USB 2.0 (2 front, 4 rear)
1 - RJ-45 (rear)
1 - DVI-D (rear)
1 - VGA (rear)
1 - Headphone (front)
1 - Microphone (front)
1 - Audio-in (rear)
1 - Audio out (rear)

I/O Ports - Optional
4 - USB 3.0 via optional 4-port super speed full-height PCIe x1 card

BAYS

1 -- 5.25" external
1 -- 3.5" internal
Standard Features and Configurable Modules

**SLOTS**
1 - PCIe x16
3 - PCIe x1
1 - PCI MiniPCIe

**FORM FACTOR AVAILABLE**
Form Factor
Microtower

**SERVICE AND SUPPORT**
On-site Warranty

*Note 1*: 1-1-1, limited warranty delivers on-site, next business-day service for parts and labor and includes free telephone support. 24 x 7. Global coverage ensures that any product purchased in one country and transferred to another non-restricted country will remain fully covered under the original warranty and service offering. One-year onsite and labor are not available in all countries.

*Note 1*: Terms and conditions may vary by country. Certain restrictions and exclusions apply. Other warranty variations may be offered in your region.

*Note 2*: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

*Note 3*: Technical telephone support applies only to HP-configured Compaq and third-party HP-qualified hardware and software. Toll-free calling and 24 x 7 support may not be available in some countries.
SYSTEM UNIT

Dimensions (WxDxH) 6.50 x 15.31 x 14.49 in
16.5 x 38.9 x 36.8 cm

Weight 15.28 lbs to 15.83 lbs (approximate)
6.932 kg to 7.18 kg (approximate)

Packaging Dimensions (LxWxH) 19.52 x 9.45 x 20.39 in
496x 240 x 518 mm

Shipping Weight 1.94 lb ~22.49 lb
9.952 kg ~10.2 kg

Temperature Operating 32° to 104° F (0 to 40° C)
Non-operating -22° to 149° F (-30° to 65° C)

Relative Humidity Operating 10% to 90% (non-condensing at ambient)
Non-operating 5% to 95% (non-condensing at ambient)

Shock Operating 40 G, half-sine
Non-operating 35G, T-Shock, 165 cm/sec half sine, 2-3 ms

Maximum Altitude (unpressurized) Operating 10,000 ft (3048 m)
Non-operating 30,000 ft (9144 m)

Environmental TAA Compliant Yes

For accessibility information on HP products, please visit: http://www.hp.com/accessibility.

INTEL HD GRAPHICS

VGA Controller Integrated
DVI-D Integrated
Bus Type PCI Express x16
RAMDAC Integrated, 350 MHz

Intel graphics do not have dedicated memory but utilizes some of the computer's system memory. The amount of memory used for graphics depending on the amount of system memory installed, BIOS settings, operating system, and system load. 32 MB is pre-allocated for graphics use at system boot time. Additional memory can be allocated at boot time by the BIOS for PAVP (Protected Audio Video Playback) support for playback of protected video content.

Additional memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (DVMT), to provide an optimal balance between graphics and system memory use.

Maximum Graphics Memory

Microsoft Windows XP Up to 1GB
Microsoft Windows 7 Up to 1.7GB

NOTE: the actual amount of maximum graphics memory can be less than the amounts listed above depending upon your computer's configuration.

HW Video Decode

AVC/VC1/MPEG2/JPEG/MJPEG/PAVP

Maximum Color Depth

32 bits/pixel

3rd Generation Core processors:
Graphics/Video API Support

- The Processor Graphics contains a refresh of the seventh generation graphics core enabling substantial gains in performance and lower power consumption. Up to 16 EU support.
- Next Generation Intel Clear Video Technology HD Support is a collection of video playback and enhancement features that improve the end user's viewing experience
  - Encode/transcode HD content
  - Playback of high definition content including Blu-ray Disc
  - Superior image quality with sharper, more colorful images
  - Playback of Blu-ray disc S3D content using HDMI (V.1.4 with 3D)
- DirectX Video Acceleration (DXVA) support for accelerating video processing
  - Full AVC/VC1/MPEG2 HW Decode
- Advanced Scheduler 2.0, 1.0, XPDM support
- Windows 7, Windows XP, OSX, Linux OS Support
- DirectX 11, DirectX 10.1, DirectX 10, DirectX 9 support
- OpenGL 3.3 support

2nd Generation Core processors:

- The Processor Graphics contains a refresh of the sixth generation graphics core enabling substantial gains in performance and lower power consumption.
- Next Generation Intel Clear Video Technology HD support is a collection of video playback and enhancement features that improve the end user's viewing experience.
  - Encode/transcode HD content
  - Playback of high definition content including Blu-ray Disc
  - Superior image quality with sharper, more colorful images
  - Playback of Blu-ray disc S3D content using HDMI (V.1.4 with 3D)
- DirectX Video Acceleration (DXVA) support for accelerating video processing
  - Full AVC/VC1/MPEG2 HW Decode
- Advanced Scheduler 2.0, 1.0, XPDM support
- Windows 7, XP, Windows Vista, OSX, Linux OS Support
- DirectX 10.1, DirectX 10, DirectX 9 support
- OpenGL 3.0 support

Supported Display Resolutions and Refresh Rates

**NOTE:** other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

<table>
<thead>
<tr>
<th>Resolution</th>
<th>Analog</th>
<th>Digital</th>
</tr>
</thead>
<tbody>
<tr>
<td>640x480</td>
<td>85</td>
<td>60</td>
</tr>
<tr>
<td>800x600</td>
<td>85</td>
<td>60</td>
</tr>
<tr>
<td>1024x768</td>
<td>85</td>
<td>60</td>
</tr>
<tr>
<td>1280x720</td>
<td>85</td>
<td>60</td>
</tr>
<tr>
<td>1280x1024</td>
<td>85</td>
<td>60</td>
</tr>
<tr>
<td>1440x900</td>
<td>75</td>
<td>60</td>
</tr>
<tr>
<td>1600x1200</td>
<td>85</td>
<td>60</td>
</tr>
<tr>
<td>1680x1050</td>
<td>75</td>
<td>60</td>
</tr>
<tr>
<td>1920x1080</td>
<td>85</td>
<td>60-R</td>
</tr>
<tr>
<td>1920x1200</td>
<td>85</td>
<td>60-R</td>
</tr>
<tr>
<td>1920x1440</td>
<td>85</td>
<td>N/A</td>
</tr>
<tr>
<td>2048x1536</td>
<td>75</td>
<td>N/A</td>
</tr>
</tbody>
</table>
ENVIRONMENTAL INFORMATION

Unit Environment and Operating Conditions

General Unit Operating Guidelines

- Keep the computer away from excessive moisture, direct moisture and the extremes of heat and cold, to ensure that unit is operated within the specified operating range.
- Leave a 4 in (10.2 cm) clearance on all vented sides of the computer to permit the required airflow.
- Never restrict airflow into the computer by blocking any vents or air intakes.
- Do not stack computers on top of each other or place computers so near each other that they are subject to each other's re-circulated or preheated air.
- Occasionally clean the air vents on the front, back, and any other vented side of the computer. Lint, dust and other foreign matter can block the vents and limit the airflow.

If the computer is to be operated within a separate enclosure, intake and exhaust ventilation must be provided on the enclosure, and the same operating guidelines listed above will still apply.

Eco-Label Certifications & declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

IT ECO declaration This product conforms to the examination standards (2003 version) under JEITA's Label System.

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Microtower model is based on a typically configured product.

Energy Consumption

<table>
<thead>
<tr>
<th></th>
<th>115 VAC</th>
<th>230 VAC</th>
<th>100 VAC</th>
</tr>
</thead>
<tbody>
<tr>
<td>Normal Operation</td>
<td>58.2 W</td>
<td>58.86 W</td>
<td>57.97 W</td>
</tr>
<tr>
<td>Sleep (ENERGY STAR® low power mode)</td>
<td>1.96 W</td>
<td>1.97 W</td>
<td>1.96 W</td>
</tr>
<tr>
<td>Off</td>
<td>0.92 W</td>
<td>0.92 W</td>
<td>0.92 W</td>
</tr>
</tbody>
</table>

NOTE: Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured model.

Heat Dissipation*

<table>
<thead>
<tr>
<th></th>
<th>115 VAC</th>
<th>230 VAC</th>
<th>100 VAC</th>
</tr>
</thead>
<tbody>
<tr>
<td>Normal Operation</td>
<td>200 BTU/hr</td>
<td>201BTU/hr</td>
<td>198 BTU/hr</td>
</tr>
<tr>
<td>Sleep</td>
<td>7 BTU/hr</td>
<td>7 BTU/hr</td>
<td>7 BTU/hr</td>
</tr>
<tr>
<td>Off</td>
<td>3 BTU/hr</td>
<td>3 BTU/hr</td>
<td>3 BTU/hr</td>
</tr>
</tbody>
</table>

NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)

<table>
<thead>
<tr>
<th></th>
<th>Typically Configured</th>
<th>Sound Power (LWAd, bels)</th>
<th>Sound Pressure (LpAm, decibels)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Idle</td>
<td></td>
<td>3.6</td>
<td>24</td>
</tr>
<tr>
<td>Fixed Disk (random writes)</td>
<td>3.7</td>
<td>26</td>
<td></td>
</tr>
</tbody>
</table>

Longevity and Upgrading

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features
and/or components contained in the product may include:

- Intel LGA775 processor socket
- 1 empty PCI slot (w/ optional PCI riser card), or
- 1 empty PCIe x16 slot (w/optional PCIe riser card)
- 1 internal drive slot
- 1 Slimline optical drive slot
- 3 memory slots
- 1 Serial/Parallel Port (optional)

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production

**Batteries**

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain:

- Mercury greater the 5ppm by weight
- Cadmium greater than 10ppm by weight

- Battery size: CR2032 (coin cell)
- Battery type: Lithium

**Batteries**

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2002/95/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product contains 0% post-consumer recycled plastic (by wt.)
- This product is 95% recyclable when properly disposed of at end of life.

**Packaging Materials**

- External:
  - PAPER/Corrugated 960 g
- Internal:
  - PLASTIC/EPS (Expanded Polystyrene) 163 g
  - PLASTIC/Polyethylene low density 58 g
- The PAPER/Corrugated material contains at least 50% recycled content.
- The PLASTIC/EPS (Expanded Polystyrene) material contains at least 0% recycled content.
- The PLASTIC/Polyethylene low density material contains at least 0% recycled content.

**RoHS2 Compliance**

Hewlett-Packard is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP’s goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis. By July 1, 2006, RoHS substances will be virtually eliminated (virtually = to levels below legal limits) for all HP electronic products subject to the RoHS Directive, except where it is widely recognized that there is no technically feasible alternative (as indicated by an exemption under the EU RoHS Directive).

**Material Usage**

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at: [http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html](http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html))
Asbestos  
Certain Azo Colorants  
Certain Brominated Flame Retardants - may not be used as flame retardants in plastics  
Cadmium  
Chlorinated Hydrocarbons  
Chlorinated Paraffins  
Formaldehyde  
Halogenated Diphenyl Methanes  
Lead carbonates and sulfates  
Lead and Lead compounds  
Mercuric Oxide Batteries  
Ozone Depleting Substances  
Polybrominated Biphenyls (PBBs)  
Polybrominated Biphenyl Ethers (PBBEs)  
Polybrominated Biphenyl Oxides (PBBOs)  
Polychlorinated Biphenyl (PCB)  
Polychlorinated Terphenyls (PCT)  
Polyvinyl Chloride (PVC) - except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.  
Radioactive Substances  
Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)  
Nickel finishes that release greater than 0.5 micro-grams/cm²/week, measured according to EN 1811:1998, are not used on any product surface designed to be frequently handled or touched by users.

Packaging  
HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.  
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.  
- Design packaging materials for ease of disassembly.  
- Maximize the use of post-consumer recycled content materials in packaging materials.  
- Use readily recyclable packaging materials such as paper and corrugated materials.  
- Reduce size and weight of packages to improve transportation fuel efficiency.  
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and Recycling  
Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas.  
To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.  

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

Hewlett-Packard Corporate Environmental Information  
For more information about HP's commitment to the environment:  
Global Citizenship Report  
Eco-label certifications  
ISO 14001 certificates:  
http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html
QuickSpecs

System Unit Specifications and Environmental Data

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